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EGF1A, EGF1B, EGF1C, EGF1D

Vishay General Semiconductor

Surface Mount Glass Passivated Ultrafast Rectifier

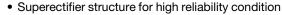
SUPERECTIFIER®



DO-214BA (GF1)

PRIMARY CHARACTERISTICS						
I _{F(AV)}	1.0 A					
V _{RRM}	50 V, 100 V, 150 V, 200 V					
I _{FSM}	30 A					
t _{rr}	50 ns					
V _F	1.0 V					
T _J max.	175 °C					
Package	DO-214BA (GF1)					
Diode variations	Single die					

FEATURES





· Cavity-free glass-passivated junction

Ideal for automated placement

(e3)

• Ultrafast reverse recovery time

ROHS

Low switching losses, high efficiency

• High forward surge capability

 Meets MSL level 1, per J-STD-020, LF maximum peak of 250 °C

AEC-Q101 qualified

 Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer, automotive and telecommunication.

MECHANICAL DATA

Case: DO-214BA, molded epoxy over glass body
Molding compound meets UL 94 V-0 flammability rating
Base P/N-E3 - RoHS-compliant, commercial grade
Base P/NHE3 - RoHS-compliant, AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test, HE3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	EGF1A	EGF1B	EGF1C	EGF1D	UNIT	
Device marking code		EA	EB	EC	ED		
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	150	200	V	
Maximum RMS voltage	V _{RMS}	35	70	105	140	V	
Maximum DC blocking voltage	V _{DC}	V _{DC} 50 100 150 200			200	V	
Maximum average forward rectified current at T _L = 125 °C	I _{F(AV)}		Α				
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	30				Α	
Operating junction and storage temperature range	T _J , T _{STG}	- 65 to + 175				°C	

EGF1A, EGF1B, EGF1C, EGF1D

Vishay General Semiconductor

ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)								
PARAMETER	TEST CONDITIONS		SYMBOL	EGF1A	EGF1B	EGF1C	EGF1D	UNIT
Maximum instantaneous forward voltage	1.0 A		V _F ⁽¹⁾	V _F ⁽¹⁾ 1.0				V
Maximum DC reverse current		T _A = 25 °C	I _R ⁽¹⁾	5.0			μA	
at rated DC blocking voltage		T _A = 125 °C	'R`'		5	0		μΛ
Typical reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A},$ $I_{rr} = 0.25 \text{ A}$		t _{rr}	50				ns
Typical junction capacitance	4.0 V, 1 MHz		CJ	15				pF

Note

⁽¹⁾ Pulse test: 300 µs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER SYMBOL EGF1A EGF1B EGF1C EGF1D U						UNIT
Typical thermal resistance	R _{0JA} (1)	85			°C/W	
Typical thermal resistance		30				C/VV

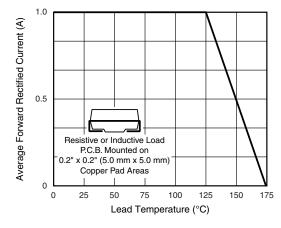
Note

⁽¹⁾ Thermal resistance from junction to ambient and from junction to lead, PCB mounted on 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas

ORDERING INFORMATION (Example)							
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE			
EGF1D-E3/67A	0.104	67A	1500	7" diameter plastic tape and reel			
EGF1D-E3/5CA	0.104	5CA	6500	13" diameter plastic tape and reel			
EGF1DHE3/67A (1)	0.104	67A	1500	7" diameter plastic tape and reel			
EGF1DHE3/5CA (1)	0.104	5CA	6500	13" diameter plastic tape and reel			

Note

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise specified)





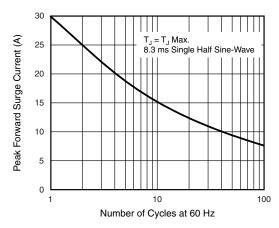


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

⁽¹⁾ AEC-Q101 qualified

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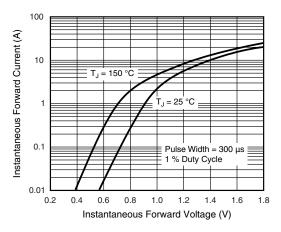


Fig. 3 - Typical Instantaneous Forward Characteristics

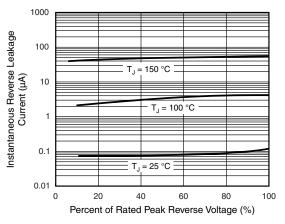


Fig. 4 - Typical Reverse Leakage Characteristics

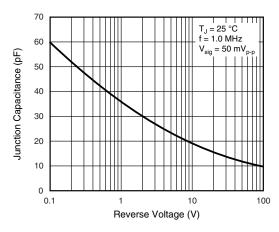


Fig. 5 - Typical Junction Capacitance

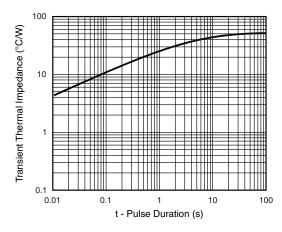


Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-214BA (GF1) **Mounting Pad Layout** 0.076 (1.93) 0.066 (1.68) 0.066 (1.68) MAX. 0.040 (1.02) MIN. 0.187 (4.75) 0.167 (4.24) 0.015 (0.38) 0.0065 (0.17) 0.060 (1.52) MIN. 0.108 (2.74) 0.118 (3.00) 0.098 (2.49) 0.100 (2.54) 0.220 (5.58) 0.114 (2.90) 0.006 (0.152) TYP 0.060 (1.52) 0.094 (2.39) 0.030 (0.76) 0.226 (5.74) 0.196 (4.98)



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